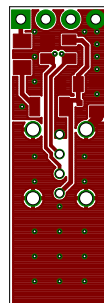


DRILL CHART: TOP TO BOTTOM

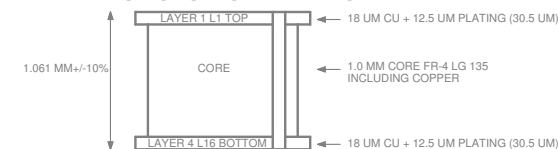
Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	26	YES
×	2	31	0.80	4	YES
▣	3	40	1.02	4	YES
◇	4	53	1.35	4	YES



LINE WIDTH IMPEDANCE CHART FOR REFERENCE

Class	USB	Type	Diff Coated Coplanar Waveguide With Ground 1B	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

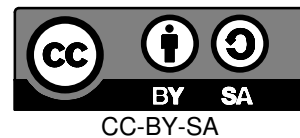
STACK-UP FOR REFERENCE



NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
2. ALL DIMENSIONS ARE GIVEN IN MILLIMETERS EXCEPT TRACE WIDTH/SPACE.
3. CIRCUIT PATHS ARE FOR REFERENCE ONLY.
4. HOLE SIZES SHOWN ARE FINISHED DIAMETERS AFTER PLATING.
5. BOARD PLATED USING REFLOW OR SIMILAR METHOD.
6. BOARD TO HAVE WHITE SOLDER MASK ON PLATED SURFACES USING WET FILM SR1100 OR SR1010 EPOXY.
EQUIVALENT WET OR DRY FILM MAY BE USED.
7. SILKSCREEN BOARD USING BLACK INK. DISTORTION OF SILKSCREEN IS ACCEPTABLE OVER TRACES. EPOXY INK ON PLATED LANDS IS NOT ACCEPTABLE.
8. THE FOLLOWING INFORMATION APPLIES TO THIS BOARD:

- * 2 COPPER LAYERS
- * 1 MM BOARD THICKNESS
- * REQUIRES TOP AND BOTTOM SIDE SILKSCREENS



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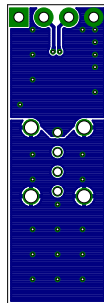
23/07/14 00:17

Component Side (.CMP)

Rev. A

DRILL CHART: TOP TO BOTTOM

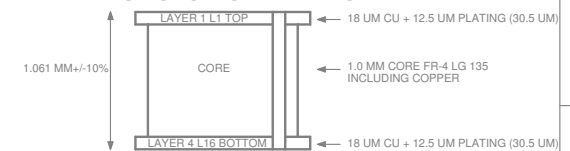
Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	26	YES
×	2	31	0.80	4	YES
▣	3	40	1.02	4	YES
◇	4	53	1.35	4	YES



LINE WIDTH IMPEDANCE CHART FOR REFERENCE

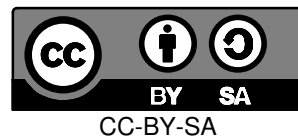
Class	USB	Type	Diff Coated Coplanar Waveguide With Ground 1B	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

STACK-UP FOR REFERENCE



NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
2. ALL DIMENSIONS ARE GIVEN IN MILLIMETERS EXCEPT TRACE WIDTH/SPACE
3. CIRCUIT PATHS ARE FOR REFERENCE ONLY.
4. HOLE SIZES SHOWN ARE FINISHED DIAMETERS AFTER PLATING.
5. BOARD PLATED USING REFLOW OR SIMILAR METHOD.
6. BOARD TO HAVE WHITE SOLDER MASK ON PLATED SURFACES USING WET FILM SR100 OR SR1010 EPOXY.
EQUIVALENT WET OR DRY FILM MAY BE USED.
7. SILKSCREEN BOARD USING BLACK INK. DISTORTION OF SILKSCREEN IS ACCEPTABLE OVER TRACES. EPOXY INK ON PLATED LANDS IS NOT ACCEPTABLE
8. THE FOLLOWING INFORMATION APPLIES TO THIS BOARD:
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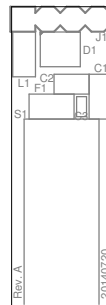
Domino Single USB

23/07/14 00:17

Solder side (.SOL)

Rev. A

Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	26	YES
×	2	31	0.80	4	YES
□	3	40	1.02	4	YES
◇	4	53	1.35	4	YES



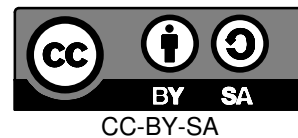
Class	USB	Type	Diff Coated Coplanar Waveguide With Ground 1B	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

Diagram illustrating the cross-section of a PCB core structure. The layers are labeled as follows:

- 18 UM CU + 12.5 UM PLATING (30.5 UM)
- LAYER 1 LT1 TOP
- CORE
- 1.0 MM CORE FR-4 LG 135 INCLUDING COPPER
- LAYER 4 LT6 BOTTOM
- 18 UM CU + 12.5 UM PLATING (30.5 UM)

The diagram also indicates a 0% dimension on the left side.

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
2. ALL DIMENSIONS ARE GIVEN IN MILLIMETERS EXCEPT TRACE WIDTH/SPACE
3. CIRCUIT PATHS ARE FOR REFERENCE ONLY.
4. HOLE SIZES SHOWN ARE FINISHED DIAMETERS AFTER PLATING.
5. BOARD PLATED USING REFLOW OR SIMILAR METHOD.
6. BOARD TO HAVE WHITE SOLDER MASK ON PLATED SURFACES USING WET FILM SR100 OR SR1010 EPOXY.
EQUIVALENT WET OR DRY FILM MAY BE USED.
7. SILKSCREEN BOARD USING BLACK INK. DISTORTION OF SILKSCREEN IS ACCEPTABLE OVER TRACES. EPOXY INK ON PLATED LANDS IS NOT ACCEPTABLE
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Silk screen CMP (.PLC)

Rev. A

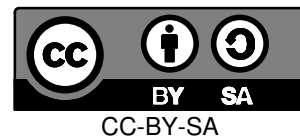
DRILL CHART: TOP TO BOTTOM

LINE WIDTH IMPEDANCE CHART FOR REFERENCE				
Class	USB	Type	Diff Coated Coplanar Waveguide With Ground 1B	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

STACK-UP FOR REFERENCE

NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR 4 TQ 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
2. ALL DIMENSIONS ARE GIVEN IN MILLIMETERS EXCEPT TRACE WIDTH/SPACE
3. CIRCUIT PATHS ARE FOR REFERENCE ONLY.
4. HOLE SIZES SHOWN ARE FINISHED DIAMETERS AFTER PLATING.
5. BOARD PLATED USING REFLOW OR SIMILAR METHOD.
6. BOARD TO HAVE WHITE SOLDER MASK ON PLATED SURFACES USING WET FILM SR100 OR SR1010 EPOXY,
EQUIVALENT WET OR DRY FILM MAY BE USED.
7. SILKSCREEN BOARD USING BLACK INK. DISTORTION OF SILKSCREEN IS ACCEPTABLE OVER TRACES, EPOXY INK ON PLATED LANDS IS NOT ACCEPTABLE
8. THE FOLLOWING INFORMATION APPLIES TO THIS BOARD:
 - * 2 COPPER LAYERS
 - * 1 MM BOARD THICKNESS
 - * REQUIRES TOP AND BOTTOM SIDE SILKSCREENS

MM \pm 10%

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Silk screen SOL (.PLS)

Rev. A

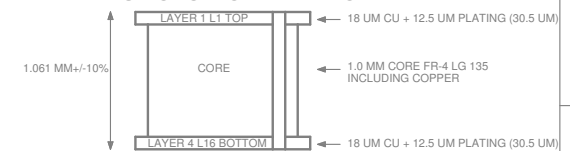
DRILL CHART: TOP TO BOTTOM

Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	26	YES
×	2	31	0.80	4	YES
▣	3	40	1.02	4	YES
◇	4	53	1.35	4	YES

LINE WIDTH IMPEDANCE CHART FOR REFERENCE

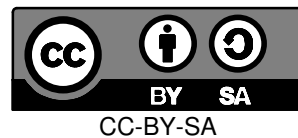
Class	USB	Type	Diff Coated Coplanar Waveguide With Ground 1B	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

STACK-UP FOR REFERENCE



NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
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23/07/14 00:17

Solder stop mask CMP (.STC)

Rev. A

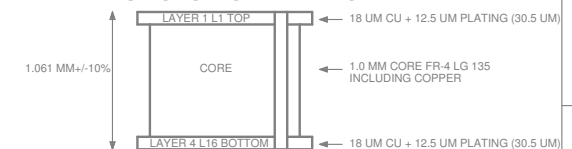
DRILL CHART: TOP TO BOTTOM

Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	26	YES
×	2	31	0.80	4	YES
▣	3	40	1.02	4	YES
◇	4	53	1.35	4	YES

LINE WIDTH IMPEDANCE CHART FOR REFERENCE

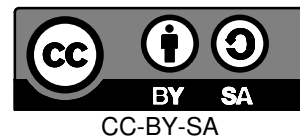
Class	USB	Type	Diff Coated Coplanar Waveguide With Ground 1B	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

STACK-UP FOR REFERENCE



NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
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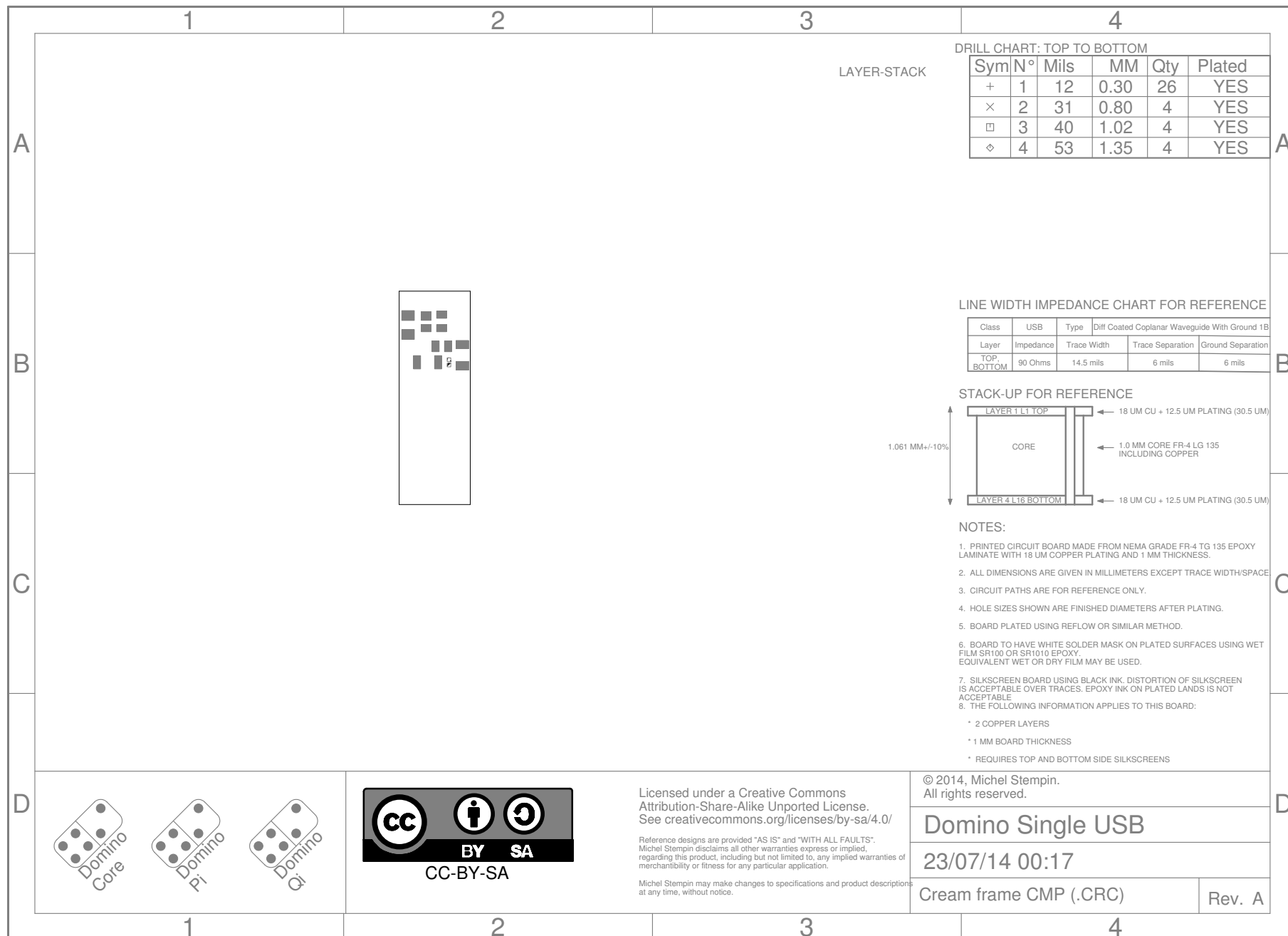
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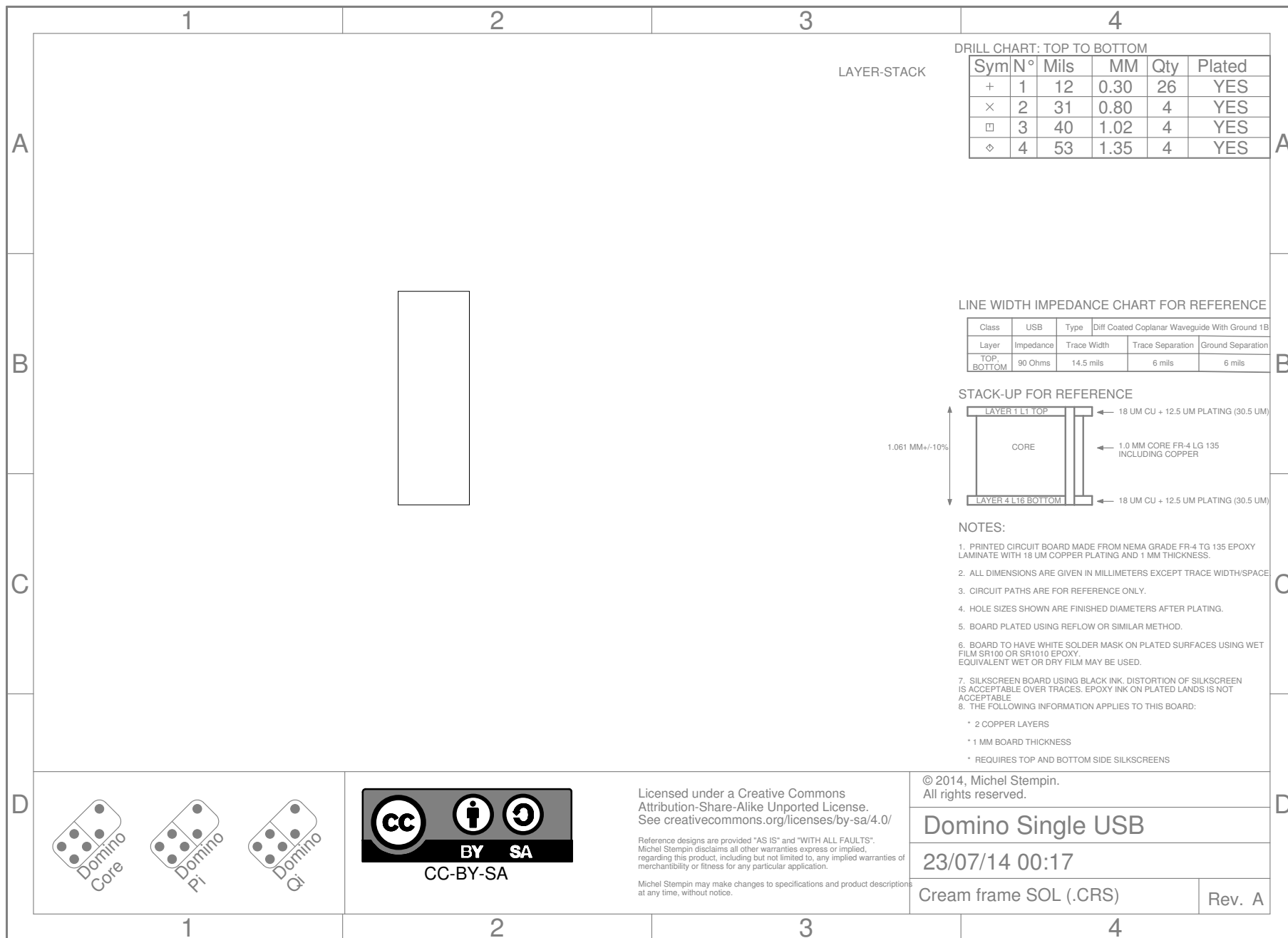
Domino Single USB

23/07/14 00:17

Solder stop mask SOL (.STS)

Rev. A





Domino Core

Domino Pi

Domino Qi

CC

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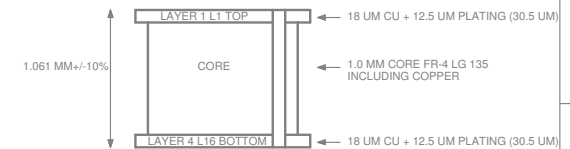
DRILL CHART: TOP TO BOTTOM

Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	26	YES
×	2	31	0.80	4	YES
▣	3	40	1.02	4	YES
◇	4	53	1.35	4	YES

LINE WIDTH IMPEDANCE CHART FOR REFERENCE

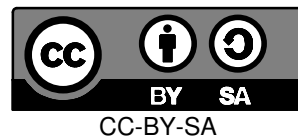
Class	USB	Type	Diff Coated Coplanar Waveguide With Ground 1B	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

STACK-UP FOR REFERENCE



NOTES:

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
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3. CIRCUIT PATHS ARE FOR REFERENCE ONLY.
4. HOLE SIZES SHOWN ARE FINISHED DIAMETERS AFTER PLATING.
5. BOARD PLATED USING REFLOW OR SIMILAR METHOD.
6. BOARD TO HAVE WHITE SOLDER MASK ON PLATED SURFACES USING WET FILM SR100 OR SR1010 EPOXY.
EQUIVALENT WET OR DRY FILM MAY BE USED.
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23/07/14 00:17

Drill data (.DRD)

Rev. A

Sym	N°	Mils	MM	Qty	Plated
+	1	12	0.30	26	YES
×	2	31	0.80	4	YES
□	3	40	1.02	4	YES
◇	4	53	1.35	4	YES

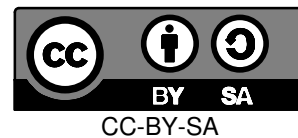
Class	USB	Type	Diff Coated Coplanar Waveguide With Ground	
Layer	Impedance	Trace Width	Trace Separation	Ground Separation
TOP, BOTTOM	90 Ohms	14.5 mils	6 mils	6 mils

A cross-sectional diagram of a PCB. It shows a central rectangular area labeled "CORE". Above and below this core are thin horizontal layers. Arrows point from text labels to these layers. The top layer is labeled "18 UM CU + 12.5 UM PLATING (30.5 U)". The bottom layer is labeled "18 UM CU + 12.5 UM PLATING (30.5 U)". The core is labeled "1.0 MM CORE FR-4 LG 135 INCLUDING COPPER".

Diagram illustrating the cross-section of a 1.0 mm FR-4 core PCB with 18 um copper and 12.5 um plating on both top and bottom layers.

- 18 UM CU + 12.5 UM PLATING (30.5 U)
- 1.0 MM CORE FR-4 LG 135 INCLUDING COPPER
- 18 UM CU + 12.5 UM PLATING (30.5 U)

1. PRINTED CIRCUIT BOARD MADE FROM NEMA GRADE FR-4 TO 135 EPOXY LAMINATE WITH 18 UM COPPER PLATING AND 1 MM THICKNESS.
2. ALL DIMENSIONS ARE GIVEN IN MILLIMETERS EXCEPT TRACE WIDTH/SPACE
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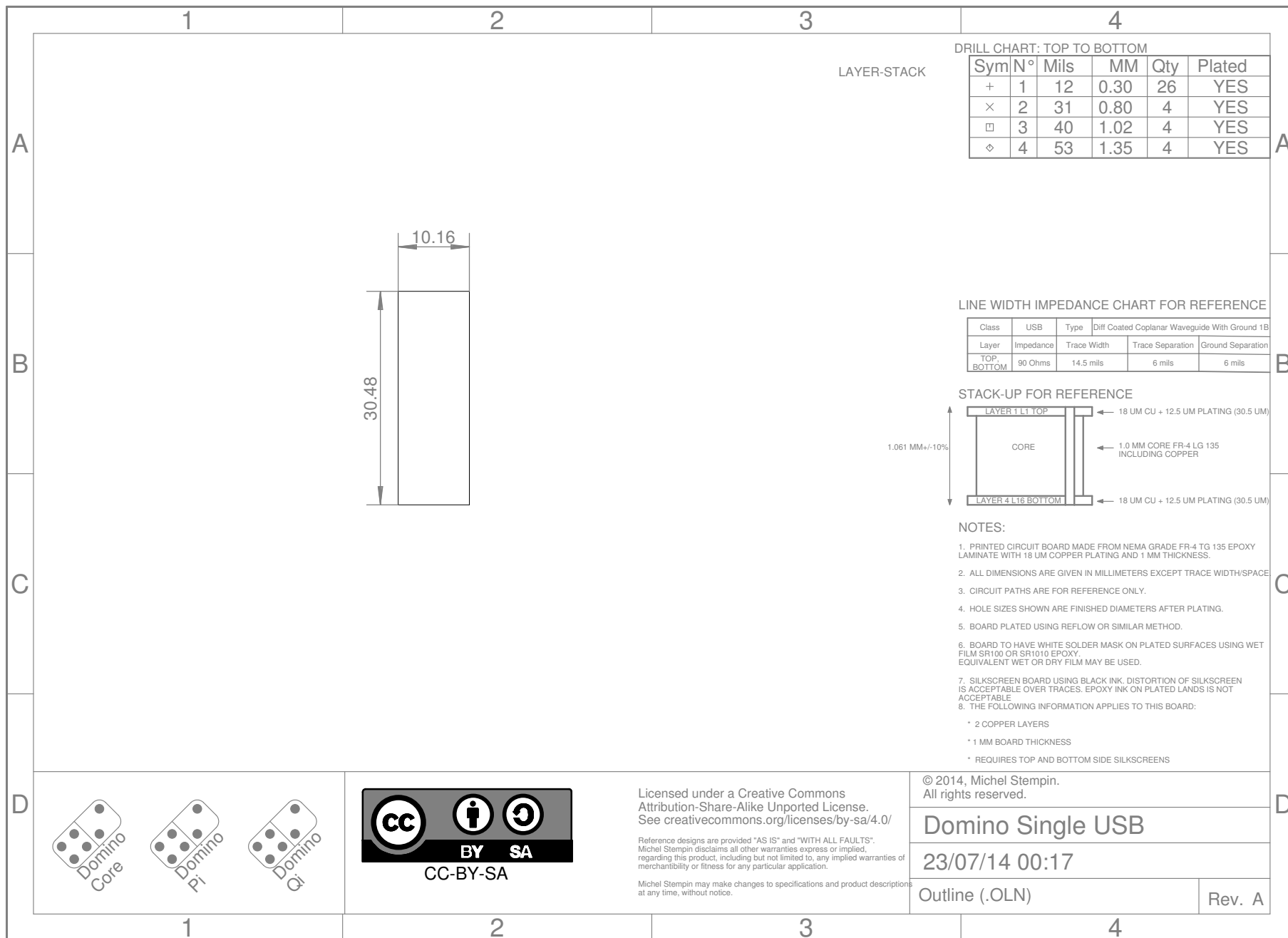
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Domino Single USB

23/07/14 00:17

Component Assembly SOL (.ASS)

Rev. A



Domino Single USB Rev. A

Item	Qty	Value	Manufacturer	Device	Package	Reference	Description	Remarks
1	11n		ANY	C1206_1n_X7R_10%_CER_500V	C1206	C1	CAP CER 1000PF 500V 10% X7R 1206	
2	110u		ANY	C0805_10u_X5R_10%_CER_16V	C0805	C2	CAP CER 10UF 16V 10% X5R 0805	
3	1100n		ANY	C0402_100n_X7R_10%_CER_50V	C0402	C3	CAP CER 0.1UF 50V 10% X7R 0402	
4	1YSSR05		YEASHIN	YSSR05	SOT143B	D1	TVS DIODE ARRAY 2CH 5V SOT143	
5	1OZCA0050FF2G		BEL FUSE INC	0ZCG0110FF2C	PTC1206	F1	PTC RESETTABLE 1.10A 8V CHIP 1812	
6	1MH4-1		ANY	MH4-1-0.1	MH4-1-0.1	J1	CONN HEADER VERT .100 1ROW 4POS 8.08 HEAD 3.05 TAIL 15AU	
7	1BLM31PG601SN1L		MURATA	BLM31PG601SN1L	FB1206	L1	FERRITE CHIP 600 OHM 1500MA 1206	
8	1USB_AF-020		SZJUSTWELL ELECTRONICS	USB_AF-020	USB_AF-020	S1	CONN USB A RECPT T/H R/A VERT	